Small Business Innovation Research/Small Business Tech Transfer

Single-Chip Multiple-Frequency RF MEMS Resonant Platform for Wireless Communications, Phase I



Completed Technology Project (2006 - 2006)

Project Introduction

A novel, single-chip, multiple-frequency platform for RF/IF filtering and clock reference based on contour-mode aluminum nitride (AIN) MEMS piezoelectric resonators is proposed. This system is the first of its class to implement multiple frequency filtering and clock functions on the same silicon die. The AIN MEMS piezoelectric resonators proposed in this work have their fundamental frequency defined by the lateral, in-plane dimensions of the structure and therefore can be fabricated at the same time. This feature enables the definition of different frequencies directly at the CAD-layout level without the need of any extra etching or deposition steps as required by commercially available thickness-mode resonators such as thin-film bulk acoustic wave resonators (FBARs) or quartz crystals. MEMS AIN piezoelectric resonators characterized by low motional resistance and high quality factors in ambient conditions constitute the most economical and sole solution for reconfigurable, multi-band and multi-functional wireless networks. This RF multiple-frequency (100 MHz to 3 GHz) platform will provide new levels of component miniaturization, integration and performance for wireless communication devices, enabling smaller form factors and lower costs while opening the door for longer battery life.

Primary U.S. Work Locations and Key Partners





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Organizational Responsibility

Responsible Mission Directorate:

Space Technology Mission Directorate (STMD)

Lead Center / Facility:

Glenn Research Center (GRC)

Responsible Program:

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Organizations Performing Work	Role	Туре	Location
☆Glenn Research	Lead	NASA	Cleveland,
Center(GRC)	Organization	Center	Ohio
Harmonic Devices,	Supporting	Industry	Berkeley,
Inc.	Organization		California

Primary U.S. Work Locations	
California	Ohio

Project Management

Program Director:

Jason L Kessler

Program Manager:

Carlos Torrez

Technology Areas

Primary:

└ TX05.1.6 Optimetrics

Tech Port
Printed on 12/08/2022
09:48 AM UTC